General-purpose Schottky diodes

Rev. 09 — 13 January 2010

Product data sheet

1. Product profile

1.1 General description

General-purpose Schottky diodes in small Surface-Mounted Device (SMD) plastic packages.

Table 1. Product	overview			
Type number	Package	Package		
	NXP	JEITA		
1PS76SB70	SOD323	SC-76	single diode	
1PS79SB70	SOD523	SC-79	single diode	
BAS70	SOT23	-	single diode	
BAS70H	SOD123F	-	single diode	
BAS70L	SOD882	-	single diode	
BAS70W	SOT323	SC-70	single diode	
BAS70-04	SOT23	-	dual series	
BAS70-04W	SOT323	SC-70	dual series	
BAS70-05	SOT23	-	dual common cathode	
BAS70-05W	SOT323	SC-70	dual common cathode	
BAS70-06	SOT23	-	dual common anode	
BAS70-06W	SOT323	SC-70	dual common anode	
BAS70-07	SOT143B	-	dual isolated	
BAS70-07S	SOT363	SC-88	dual isolated	
BAS70-07V	SOT666	-	dual isolated	
BAS70VV	SOT666	-	triple isolated	
BAS70XY	SOT363	SC-88	quadruple; 2 series	

1.2 Features

- High switching speed
- High breakdown voltage

1.3 Applications

- Ultra high-speed switching
- Low leakage current
- Low capacitance
- Voltage clamping



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1.4 Quick reference data

Quick reference data					
Parameter	Conditions	Min	Тур	Max	Unit
)					
forward current		-	-	70	mA
forward voltage	$I_F = 1 \text{ mA}$	<u>[1]</u> -	-	410	mV
reverse voltage		-	-	70	V
	Parameter forward current forward voltage	Parameter Conditions forward current IF = 1 mA	Parameter Conditions Min forward current - forward voltage I _F = 1 mA [1]	Parameter Conditions Min Typ forward current - - forward voltage I _F = 1 mA [1] -	ParameterConditionsMinTypMaxforward current70forward voltage $I_F = 1 \text{ mA}$ $[1]$ 410

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

2. Pinning information



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Table 3.	Pinningcontinued		
Pin	Description	Simplified outline	Symbol
BAS70-0	5; BAS70-05W		
1	anode (diode 1)		0
2	anode (diode 2)	3	3
3	cathode (diode 1), cathode (diode 2)		1 - J - 2 006aaa438
		1 2 006aaa144	
BAS70-0	6; BAS70-06W		
1	cathode (diode 1)		
2	cathode (diode 2)	3	3
3	anode (diode 1), anode (diode 2)		1-1-2
			006aaa439
		006aaa144	
BAS70-0	7		
1	cathode (diode 1)		
2	cathode (diode 2)		
3	anode (diode 2)		
4	anode (diode 1)		1 2 006aaa434
BAS70-0	7S; BAS70-07V		
1	anode (diode 1)		
2	not connected	6 5 4	6 5 4
3	cathode (diode 2)		
4	anode (diode 2)		
5	not connected		1 2 3 <i>006aaa440</i>
6	cathode (diode 1)	1 2 3 001aab5555	
BAS70V\	/		
1	anode (diode 1)		
2	anode (diode 2)		
3	anode (diode 3)		
4	cathode (diode 3)		
5	cathode (diode 2)		1 2 3 sym046
6	cathode (diode 1)	1 2 3	-

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Pin	Description	Simplified outline	Symbol
BAS70X	Y		
1	anode (diode 1)		
2	cathode (diode 2)		
3	anode (diode 3), cathode (diode 4)	0	
4	anode (diode 4)		
5	cathode (diode 3)		
6	cathode (diode 1), anode (diode 2)		1 2 3 006aaa256

[1] The marking bar indicates the cathode.

3. Ordering information

Type number	Package		
	Name	Description	Version
1PS76SB70	SC-76	plastic surface-mounted package; 2 leads	SOD323
1PS79SB70	SC-79	plastic surface-mounted package; 2 leads	SOD523
BAS70	-	plastic surface-mounted package; 3 leads	SOT23
BAS70H	-	plastic surface-mounted package; 2 leads	SOD123F
BAS70L	-	leadless ultra small plastic package; 2 terminals; body 1.0 \times 0.6 \times 0.5 mm	SOD882
BAS70W	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS70-04	-	plastic surface-mounted package; 3 leads	SOT23
BAS70-04W	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS70-05	-	plastic surface-mounted package; 3 leads	SOT23
BAS70-05W	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS70-06	-	plastic surface-mounted package; 3 leads	SOT23
BAS70-06W	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS70-07	-	plastic surface-mounted package; 4 leads	SOT143B
BAS70-07S	SC-88	plastic surface-mounted package; 6 leads	SOT363
BAS70-07V	-	plastic surface-mounted package; 6 leads	SOT666
BAS70VV	-	plastic surface-mounted package; 6 leads	SOT666
BAS70XY	SC-88	plastic surface-mounted package; 6 leads	SOT363

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4. Marking

Table 5. Marking of	codes		
Type number	Marking code ^[1]	Type number	Marking code ^[1]
1PS76SB70	S2	BAS70-05W	75*
1PS79SB70	G	BAS70-06	76*
BAS70	73*	BAS70-06W	76*
BAS70H	AH	BAS70-07	77*
BAS70L	S8	BAS70-07S	77*
BAS70W	73*	BAS70-07V	77
BAS70-04	74*	BAS70VV	N1
BAS70-04W	74*	BAS70XY	70*
BAS70-05	75*	-	-

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V _R	reverse voltage		-	70	V
l _F	forward current		-	70	mA
I _{FRM}	repetitive peak forward current	$t_p \le 1$ s; $\delta \le 0.5$	-	70	mA
I _{FSM}	non-repetitive peak forward current	$t_p \le 10 \text{ ms}$	<u>[1]</u> -	100	mA
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] $T_j = 25 \ ^\circ C$ prior to surge.

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6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per devic	e						
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u>				
	SOT23			-	-	500	K/W
	SOT143B			-	-	500	K/W
	SOT363 (BAS70-07S)			-	-	416	K/W
	SOT666 (BAS70VV)		[2]	-	-	700	K/W
	SOT666 (BAS70-07V)		[2]	-	-	416	K/W
	SOD123F		[2]	-	-	330	K/W
	SOD323			-	-	450	K/W
	SOD523		[2]	-	-	450	K/W
	SOD882		[2]	-	-	500	K/W
	SOT323			-	-	625	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point						
	SOT363 (BAS70XY)		[3]	-	-	260	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Soldering point at pins 2, 3, 5 and 6.

7. Characteristics

Table 8. T _{amb} = 25	Characteristics °C unless otherwise s	pecified.				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode	e					
VF	forward voltage		[1]			
		I _F = 1 mA	-	-	410	mV
		I _F = 10 mA	-	-	750	mV
		I _F = 15 mA	-	-	1	V
I _R	reverse current	V _R = 50 V	-	-	100	nA
		V _R = 70 V	-	-	10	μA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz	-	-	2	pF

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8. Package outline



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9. Packing information

Table 9. **Packing methods** The indicated -xxx are the last three digits of the 12NC ordering code.[1] Type number Package Description **Packing quantity** 3000 4000 8000 10000 -115 1PS76SB70 SOD323 4 mm pitch, 8 mm tape and reel -135 --1PS79SB70 **SOD523** 2 mm pitch, 8 mm tape and reel --315 -4 mm pitch, 8 mm tape and reel -115 -_ -135 BAS70 SOT23 4 mm pitch, 8 mm tape and reel -215 -235 --BAS70H SOD123F 4 mm pitch, 8 mm tape and reel -115 ---135 BAS70L SOD882 2 mm pitch, 8 mm tape and reel ----315 BAS70W SOT323 4 mm pitch, 8 mm tape and reel -115 --135 -BAS70-04 SOT23 4 mm pitch, 8 mm tape and reel -215 --235 BAS70-04W **SOT323** 4 mm pitch, 8 mm tape and reel -115 ---135 BAS70-05 SOT23 4 mm pitch, 8 mm tape and reel -215 --235 -BAS70-05W SOT323 4 mm pitch, 8 mm tape and reel -115 --135 BAS70-06 SOT23 4 mm pitch, 8 mm tape and reel -215 --235 -BAS70-06W SOT323 4 mm pitch, 8 mm tape and reel -115 -135 --BAS70-07 SOT143B 4 mm pitch, 8 mm tape and reel -215 --235 BAS70-07S SOT363 4 mm pitch, 8 mm tape and reel; T1 2 -115 ---135 3 -125 4 mm pitch, 8 mm tape and reel; T2 ---165 BAS70-07V **SOT666** 2 mm pitch, 8 mm tape and reel ---315 --4 mm pitch, 8 mm tape and reel --115 -BAS70VV SOT666 2 mm pitch, 8 mm tape and reel ---315 -4 mm pitch, 8 mm tape and reel --115 --BAS70XY SOT363 2 -115 4 mm pitch, 8 mm tape and reel; T1 -_ -135 4 mm pitch, 8 mm tape and reel; T2 3 -125 -165 --

[1] For further information and the availability of packing methods, see <u>Section 13</u>.

[2] T1: normal taping

[3] T2: reverse taping

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10. Soldering



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11. Revision history

Table 10.Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
BAS70_1PS7XSB70_SER_9	20100113	Product data sheet	-	BAS70_1PS7XSB70_SER_8
Modifications:		•		y name NXP Semiconductors, ges were made to the technical
BAS70_1PS7XSB70_SER_8	20060504	Product data sheet	-	BAS70_1PS7XSB70_SER_7
BAS70_1PS7XSB70_SER_7	20050718	Product data sheet	-	1PS76SB70_2 1PS79SB70_1 BAS70H_1 BAS70L_1 BAS70-07V_1 BAS70VV_1 BAS70W_3 BAS70-07S_4 BAS70_SERIES_6
1PS76SB70_2	20040126	Product specification	-	1PS76SB70_1
1PS79SB70_1	19980716	Product specification	-	-
BAS70H_1	20050425	Product data sheet	-	-
BAS70L_1	20030520	Product specification	-	-
BAS70-07V_1	20020117	Product specification	-	-
BAS70VV_1	20040910	Product data sheet	-	-
BAS70W_3	19990326	Product specification	-	BAS70W_2
BAS70-07S_4	20030411	Product specification	-	BAS70_07S_3
BAS70_SERIES_6	20011011	Product specification	-	BAS70_5

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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BAS70_1PS7XSB70_SER_9

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Date of release: 13 January 2010 Document identifier: BAS70_1PS7XSB70_SER_9



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